227 Deg 1mm Solder Wire







Features:

- · 1lb. spool
- · Rosin flux core
- Diameter: 1mm (0.04")
- Melting point: 227° C (441° F)
- 99.3% tin, 0.7% copper
- Also available in 6oz. spools, see Item #21-1046

Description:

Lead-Free Solder

Ideal for general purpose electronic repair and assembly use. Tin/copper formulation meets current requirements for lead free solder use.

Part Number Table

Description	Part Number
Lead Free Rosin Core Solder - Tin / Copper - 1lb	21-1041

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